

Please replace the paragraph beginning at page 2, line 9, with the following rewritten paragraph:

B1 --To solve this problem, as shown in Fig. 6(A), the conductor patterns 93 may have a trapezoid cross-section in which the width a of the bottom surface 931 is greater than the width b of the top surface 932. However, in this case, the material forming the conductor patterns 93 forces the protection film 94, which is shaped in correspondence with the conductor patterns 93, upward. Thus, as shown in Fig. 6(B), the protection film 94 may be separated from the upper surface of the substrate 2. Further, as shown in Fig. 6(C), during formation of the conductor patterns 93, a portion 939 of the conductor patterns 93 may enter the space between the bottom surface of the protection film 94 and the upper surface of the substrate 2 causing a short-circuit with the adjacent conductor pattern 93.--

Please replace the paragraph beginning at page 13, line 20, with the following rewritten paragraph:

B2 --A second embodiment of a printed circuit board will now be discussed centering on the points differing from the first embodiment. As shown in Fig. 3, in the second embodiment, an upper surface 42 of the solder resist 4 is shaped in correspondence with the arrangement of the conductor pattern 3. This is the only difference between the printed circuit boards of the second embodiment and the first embodiment.--

Please replace the paragraph beginning at page 14, line 15, with the following rewritten paragraph: